Auto Grade Tuning Fork

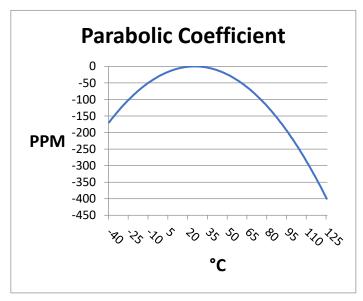


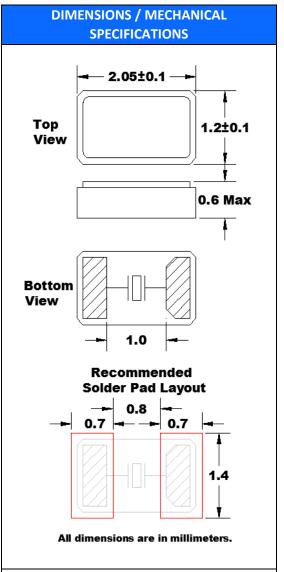
Features

- AEC-Q200 Qualified
- IATF-16949 QMS

STANDARD SPECIFICATIONS						
PARAMETERS	MAX (Unless otherwise noted)					
Frequency Range	32.768 kHz					
Frequency Tolerance @ 25°C	±20 PPM					
Frequency Stability, ref 25°C						
(Temperature Coefficient)	-0.04 PPM / (Δ°C) ²					
Temperature Range						
Turnover (TO)	+20°C ~ +30°C					
Operating (T _{OPR})	-40°C ~ +125°C					
Storage (Tstg)	-40°C ~ +125°C					
Equivalent Series Resistance (Rs)	90 kΩ					
Load Capacitance (C _L)	(See options below)					
Insulation Resistance @ 100VDC	500MΩ Min					
Drive Level	1.0μW (0.1μW Typical)					
Aging per year *@ 25°C)	±3 PPM					
Maximum Soldering Temp / Time	260°C / 10 Seconds					
Moisture Sensitivity Level (MSL) per	1					
J-STD-033						
Termination Finish	Au over Ni					
Seal Method	Seam					
Lead (Pb) Free	Yes					
RoHS Compliant	Yes					

Temperature Coefficient





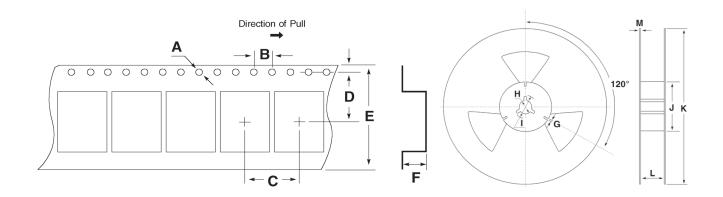
Note: Dimensional drawing is for reference to critical specifications defined by size measurements. Certain non-critical visual attributes, such as side castellations, etc. may vary.

2.05mm x 1.2mm





TAPE SPECIFICATIONS (mm)					REEL SPECIFICATIONS (mm)								
Α	В	С	D	E	F	REEL QTY	G	Н	ı	J	К	L	M
Ø1.5	4.0	4.0	3.5	8.0	0.75	-T3 = 3,000	2.0	Ø13	Ø21	Ø60	Ø180	9.0	1.2



Available Options & Part Identification for SMD Tuning Fork Crystal K12A Sample PN: FK12AEIHI0.032768-T3											
F	K12A	E	1	Н	1.0	0.032768	-T3				
Fox	<u>Model</u> <u>Number</u>	<u>Tolerance</u> E = ±20ppm	Stability I = -0.04 PPM/ (Δ°C) ²	Load Capacitance B = 6pF V = 7pF W = 9pF H = 12.5pF	Operating Temperature I = -40 ~ +125°C	<u>Frequency</u> (MHz)	Values Added Options Blank = Bulk T3 = 3,000 pcs				

Reliability Test Conditions

Please contact Abracon Quality Assurance department

2.05mm x 1.2mm

Auto Grade Tuning Fork



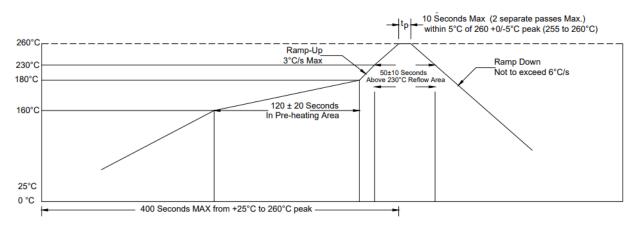
Crystal Unit Handling Precautions

1) Mounting Precautions

- If the board is deformed, such as bending after mounting, peeling of the soldered joint between the crystal resonator and board may occur producing a crack in the ceramic package, leading to loss of vacuum, destruction of the internal element, etc. Especially when repaneling the board on which it is mounted, there is a possibility that a large stress may be applied, please consider board layout and cutting method to minimize stress on products.
- When the product is automatically mounted on the board, if a large impact is applied to the crystal resonator, there is a possibility that characteristics may change / deteriorate, or the product may be broken. When mounting automatically, please set conditions considering the shock to the crystal unit. Also, please conduct the mounting test beforehand and confirm that there is no influence on the characteristics to the crystal resonator.
- Cracks may occur in the soldered part by repeated harsh temperature changes for a long time when mounting due to the board having a expansion coefficient different from that of the ceramics used in the crystal package. When using under such circumstances, please conduct test beforehand and confirm that there is no influence on the crystal unit.
- Ceramic packages are small and thin products. So, if/when you rework after mounting, please give consideration to the selection and handling of the tools to be used.

2) Soldering

Following is typical SMD Pb-free reflow profile for soldering:



Excessive heating time at high temperature may result in deterioration of the characteristics and may break the crystal unit. For manual rework, heat the lead part at 300°C or lower for 5 seconds or less.

3) Cleaning

Since a small, thin crystal chip is used for tuning fork crystal units and the frequency approximates that of an ultrasonic cleaner, the crystal chip may break easily. Therefore, DO NOT perform ultrasonic cleaning.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Crystals category:

Click to view products by Abracon manufacturer:

Other Similar products are found below:

MC405 32.0000K-R3:PURE SN 7B-27.000MBBK-T MP1-8.0 99-BU 9B-15.360MBBK-B PTX-A2JM-10.000M 9C-7.680MBBK-T H10S-12.000-18-EXT-TR R38-32.768-12.5-5PPM-NPB BTD1062E05A-513 21U15A-21.4MHZ RTX-781DF1-S-20.950 LFXTAL066198Cutt 9C-14.31818MBBK-T A-11.000MHZ-27 SPT2A-.032768B SPT2A.032768G SSPT7F-9PF20-R FX325BS-38.88EEM1201 MP-1-25.000MHZ-3L MP-1-6.000MHZ LFXTAL065253Cutt LFXTAL066431Cutt XT9S20ANA14M7456 XT9SNLANA16M 646G-24-2 7B-30.000MBBK-T 6504-202-1501 6526-202-1501 BTJ120E02C SG636PCE-20.000MC 3404 CM315D32768EZFT C1E-24.000-7-2020-R C1E-19.200-12-1530-X-R C1E-16.000-12-1530-X-R ABM11-16.000MHZ-9-B1U-T FL5000014 EUCA18-3.1872M 425F35E027M0000 17196 MS3V-T1R-32.768kHz-7pF-20PPM-TA-QC-Au VXM7-1C1-16M000 MS1V-T1K-32.768kHz-10pF-20PPM-TA-QC-Au MS1V-T1K-32.768kHz-10pF-20PPM-TA-QC-Au MS1V-T1K-32.768kHz-10pF-20PPM-TA-QC-Au MS1V-T1K-32.768kHz-10pF-20PPM-TA-QC-Au MS1V-T1R-32.768kHz-12.5pF-20PPM-TA-QC-Au MS3V-T1R-32.768kHz-9pF-20PPM-TA-QC-Au 17000 17301 16875 ECS-80-18-30B-JEM-TR